

Statement of Compliance

Requested Part

TE Internal Number1879225-2Product Description:CPF 0603 39K2 0.1% 25PPM 1K RLPart Status:ActiveMil-Spec Certifie:NoEU ROHS Directive 2011/65/EUCompliantThis declaration covers EU Directive 2011/65/EU Incl. Delegated Directive 2000/53/ECOmpliantChina ROHS 2 DirectiveOmpliant2000/53/ECOmpliantEU RELA DirectiveOmpliant2000/53/ECOmpliantChina ROHS 2 DirectiveOmpliantChina ROHS 2 DirectiveOmpliant	12 June 2023	CPF0603B3	39K2E1	(Part 1 of 1)	
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Material Declarations: MD_1879225-2	Solder	Process Capability Code:	Reflow solder capable to 260°C		
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TE Connectivity Corporation

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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